



SMT power inductors

Size 10.4 × 10.4 × 3.0 (mm)

Series/Type: **B82464A2**

Date: June 2012

Rated inductance 1 ... 330 μ H**Rated current 0.43 ... 6.8 A****Construction**

- Ferrite core
- Winding: enamel copper wire
- Winding welded to terminals

Features

- Temperature range up to +150 °C
- High rated current
- Low DC resistance
- Suitable for lead-free reflow soldering as referenced in JEDEC J-STD 020D
- Qualified to AEC-Q200
- RoHS-compatible

Applications

- Filtering of supply voltages
- Coupling, decoupling
- DC/DC converters
- Automotive electronics
- Industrial electronics

Terminals

- Base material CuFe₂P
- Layer composition Ag, Sn (lead-free)
- Electro-plated

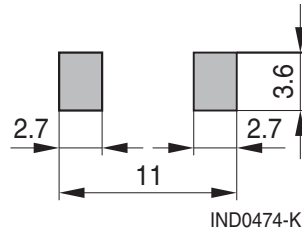
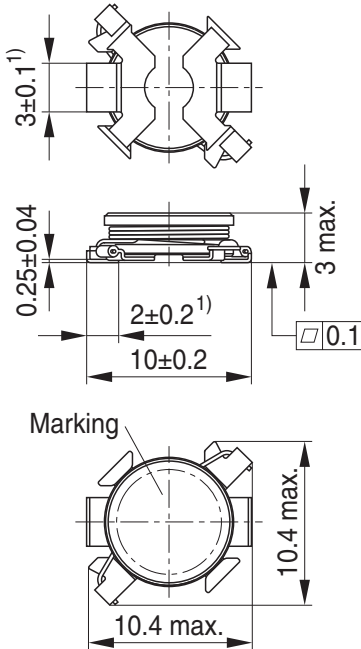
Marking

- Marking on component:
Manufacturer, L value (nH, coded),
L tolerance (coded), manufacturing date (YWWD),
two last digits of work order
- Minimum data on reel:
Manufacturer, ordering code, L value,
quantity, date of packing

Delivery mode and packing unit

- 16-mm blister tape, wound on 330-mm $\varnothing$ reel
- Packing unit: 1250 pcs./reel



SMD
Dimensional drawing and layout recommendation


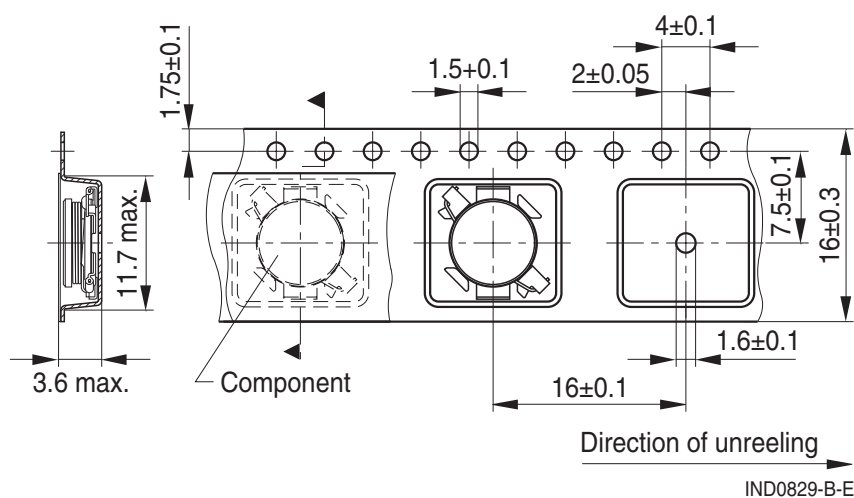
IND0474-K

Dimensions in mm

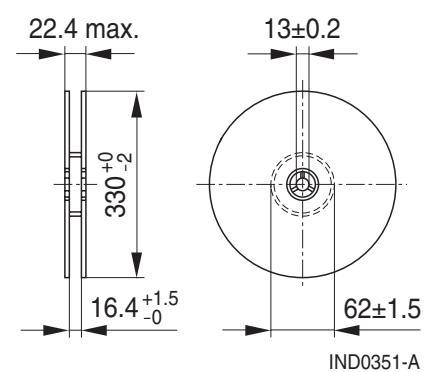
Component tolerances ± 0.2 mm unless otherwise noted.

1) Soldering area

IND0473-E-E

Taping and packing
Blister tape


IND0829-B-E

Reel


IND0351-A

Dimensions in mm

Technical data and measuring conditions

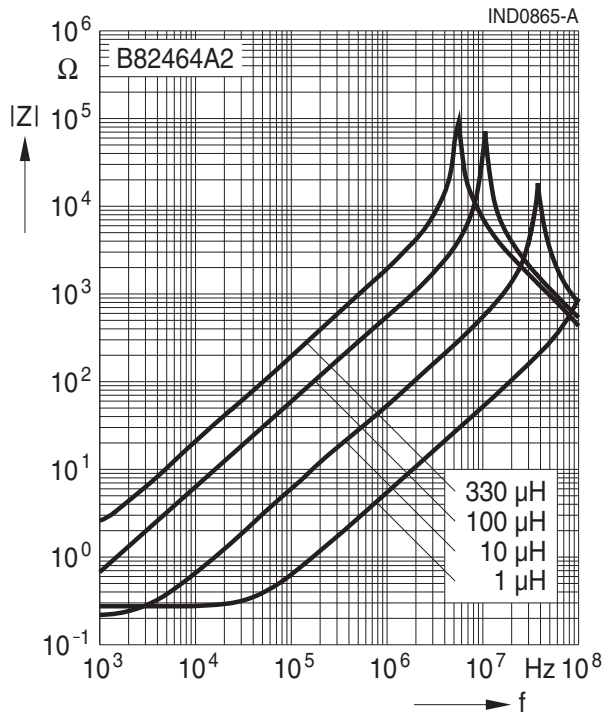
Rated inductance L_R	Measured with impedance analyzer Agilent 4294A at frequency f_L , 0.1 V, +20 °C
Rated temperature T_R	+85 °C
Rated current I_R	Max. permissible DC with temperature increase of ≤ 40 K at rated temperature
Saturation current I_{sat}	Max. permissible DC with inductance decrease $\Delta L/L_0$ of approx. 10%
DC resistance R_{max}	Measured at +20 °C
Solderability (lead-free)	Dip and look method Sn95.5Ag3.8Cu0.7: +(245 $\pm$ 5) °C, (5 $\pm$ 0.3) s Wetting of soldering area $\geq 90\%$ (based on IEC 60068-2-58)
Resistance to soldering heat	+260 °C, 40 s (as referenced in JEDEC J-STD 020D)
Climatic category	55/150/56 (to IEC 60068-1)
Storage conditions	Mounted: -55 °C ... +150 °C Packaged: -25 °C ... +40 °C, $\leq 75\%$ RH
Weight	Approx. 0.7 g

Characteristics and ordering codes

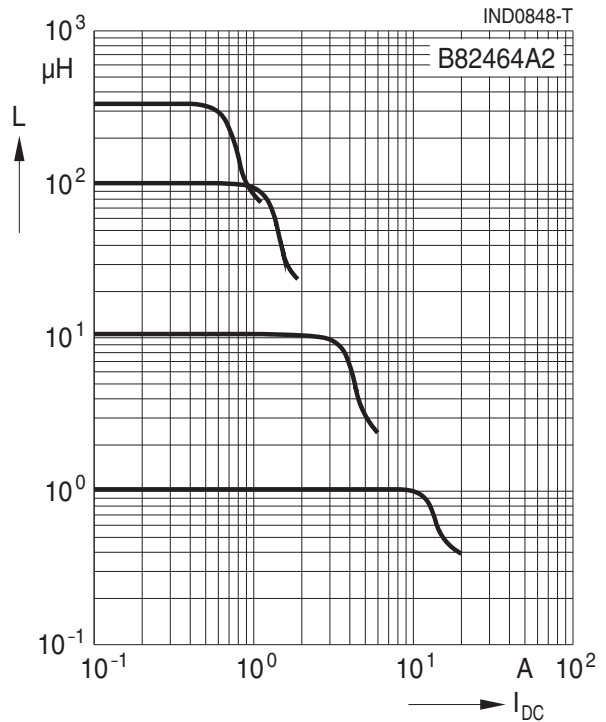
L_R μH	Tolerance	f_L MHz	I_R A	I_{sat} A	R_{max} Ω	Ordering code
1.0	$\pm 20\% \triangleq M$	0.1	6.80	9.50	0.010	B82464A2102M000
1.5		0.1	6.40	7.90	0.011	B82464A2152M000
2.2		0.1	5.60	6.70	0.014	B82464A2222M000
3.6		0.1	5.20	5.30	0.025	B82464A2362M000
4.7		0.1	4.20	4.50	0.030	B82464A2472M000
6.8		0.1	3.05	3.60	0.045	B82464A2682M000
10		0.1	2.65	3.10	0.060	B82464A2103M000
15	$\pm 10\% \triangleq K$	0.1	2.05	2.55	0.098	B82464A2153K000
22		0.1	1.72	2.05	0.135	B82464A2223K000
33		0.1	1.45	1.70	0.195	B82464A2333K000
47		0.1	1.26	1.45	0.260	B82464A2473K000
68		0.1	1.18	1.20	0.360	B82464A2683K000
100		0.1	0.86	0.95	0.550	B82464A2104K000
150		0.1	0.67	0.82	0.830	B82464A2154K000
220		0.1	0.56	0.69	1.15	B82464A2224K000
330		0.1	0.43	0.57	1.72	B82464A2334K000

SMD

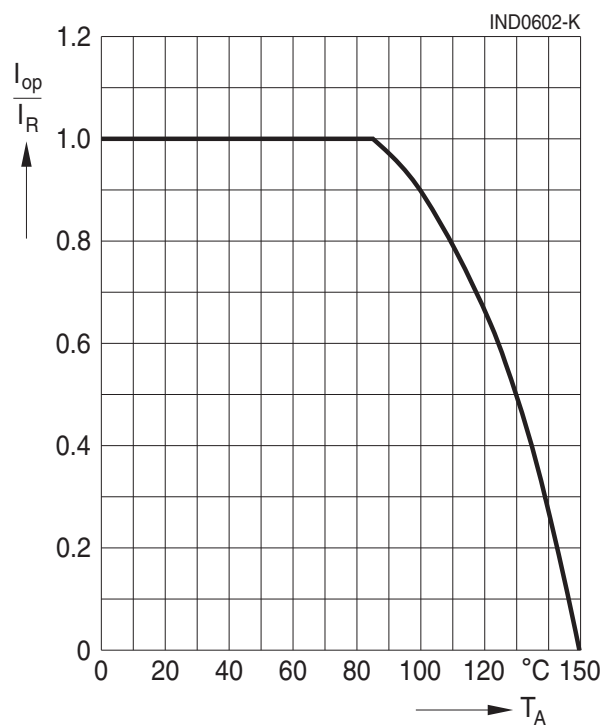
Impedance $|Z|$ versus frequency f
measured with impedance analyzer
Agilent 4294A, typical values at +20 °C



Inductance L versus DC load current I_{DC}
measured with LCR meter Agilent 4275A,
typical values at +20 °C



Current derating $I_{\text{op}}/I_{\text{R}}$
versus ambient temperature T_{A}
(rated temperature $T_{\text{R}} = +85$ °C)



Cautions and warnings

- Please note the recommendations in our Inductors data book (latest edition) and in the data sheets.
 - Particular attention should be paid to the derating curves given there.
 - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not the housing.
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. In particular, it is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.

Washing processes may damage the product due to the possible static or cyclic mechanical loads (e.g. ultrasonic cleaning). They may cause cracks to develop on the product and its parts, which might lead to reduced reliability or lifetime.
- The following points must be observed if the components are potted in customer applications:
 - Many potting materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
 - It is necessary to check whether the potting material used attacks or destroys the wire insulation, plastics or glue.
 - The effect of the potting material can change the high-frequency behaviour of the components.
- Ferrites are sensitive to direct impact. This can cause the core material to flake, or lead to breakage of the core.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.

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<u>B82464A2154K000</u>	<u>B82464A2222M000</u>	<u>B82464A2223K000</u>	<u>B82464A2224K000</u>	<u>B82464A2333K000</u>
<u>B82464A2334K000</u>	<u>B82464A2472M000</u>	<u>B82464A2473K000</u>	<u>B82464A2682M000</u>	<u>B82464A2683K000</u>